



AG/1771  
Jhu

**IN THE  
UNITED STATES  
PATENT AND TRADEMARK OFFICE**

**IN RE APPLICATION OF:** Tebbe

**CASE:** OST 011310

**SERIAL NO.:** 10/048,243

**FILED ON:** January 24, 2002

**FOR:** FLAT, FLEXIBLE, BONDED  
COMPOSITE MATERIAL

**REPLY  
TO  
OFFICE ACTION**

ASSISTANT COMMISSIONER  
FOR PATENTS  
Washington DC 20231

**ATTENTION OF:**  
AU 1771  
**EXAMINER:**  
Juska, C.

Dear Sir:

If any charges or fees must be paid in connection with the following communication, they may be paid out of our Deposit Account No. 50-0545.

This is in response to the Office Action mailed on May 6, 2004. Please consider the following remarks towards reconsideration and allowance of the present application.

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